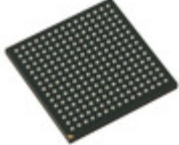
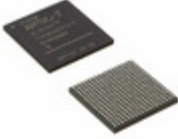


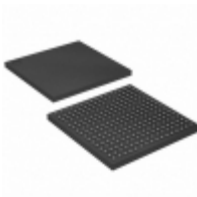
Spezifikationen	
Teilenummer	XA6SLX9-3FTG256Q
Hersteller	Xilinx
Beschreibung	IC FPGA 186 I/O 256FTGBGA
Kategorie	Integrierte Schaltungen (ICs) > Eingebettete - FPGAs
Teilstatus	2290 pcs Stock
Spannungsversorgung	1.14 V ~ 1.26 V
Gesamt-RAM-Bits	589824
Supplier Device-Gehäuse	256-FTBGA (17x17)
Serie	Automotive, AEC-Q100, Spartan®-6 LX XA
Verpackung / Gehäuse	256-LBGA
Betriebstemperatur	-40°C ~ 125°C (TJ)
Anzahl der Logikelemente / Zellen	9152
Anzahl der LABs / CLBs	715
Anzahl der E / A	186
Befestigungsart	Surface Mount

sein:

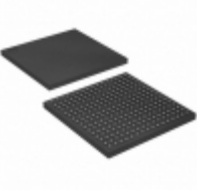
XA6SLX9-3CSG324Q
Xilinx Inc.
IC FPGA 200 I/O 324CSGBGA



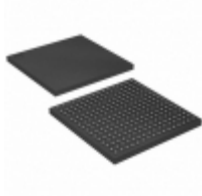
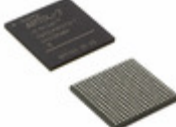
XA6SLX9-3CSG225Q
Xilinx Inc.
IC FPGA 160 I/O 225CSGBGA



XA6SLX9-2FTG256Q
Xilinx Inc.
IC FPGA 186 I/O 256FTGBGA



Two Xilinx XA6SLX9-2FTG256I FPGAs are shown. One is a top-down view of the device, and the other is a side view showing the pins and the package type (256FTGBGA).

Two black, square integrated circuits (FPGAs) are shown against a light gray background. The chip in the foreground is angled, revealing its top surface which is covered in a dense grid of small, square solder pads (BGA package). The second chip is positioned behind and slightly to the left of the first, showing its bottom surface which has a few larger, rectangular pads.

XA6SLX9-3CSG324I
Xilinx Inc.
IC FPGA 200 I/O 324CSGBGA

Mehr

Schlüsselwort	XA6SLX9-3FTG256Q Datenblatt	XA6SLX9-3FTG256Q-Datenblätter	XA6SLX9-3FTG256Q PDF	Xilinx XA6SLX9-3FTG256Q
XA6SLX9-3FTG256Q Electronic	XA6SLX9-3FTG256Q-Komponenten	XA6SLX9-3FTG256Q-Verteiler	XA6SLX9-3FTG256Q-Bild	XA6SLX9-3FTG256Q-Teil
XA6SLX9-3FTG256Q Preis	XA6SLX9-3FTG256Q Hersteller	XA6SLX9-3FTG256Q Bild	XA6SLX9-3FTG256Q Aktie	XA6SLX9-3FTG256Q Inventar
XA6SLX9-3FTG256Q Neu	XA6SLX9-3FTG256Q Original	XA6SLX9-3FTG256Q garantiert	XA6SLX9-3FTG256Q RFQ	XA6SLX9-3FTG256Q Online bestellen